

RoHS Compliant Product
A suffix of "C" specifies halogen & lead-free

FEATURES

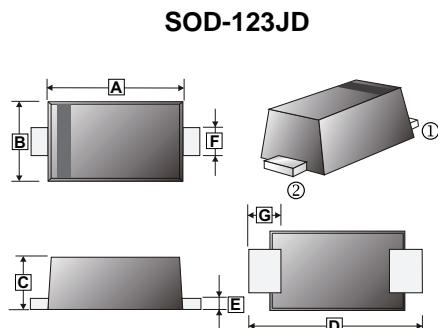
- Low forward surge current
- Ideal for surface mounted applications
- Low leakage current

MECHANICAL DATA

- Case: JEDEC SOD-123JD, molded plastic over passivated chip
- Terminals: Solder Plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end

MARKING

Product	Marking Code	Product	Marking Code
SM120JD	S14	SM1100JD	S110
SM140JD	S14	SM1150JD	S115
SM160JD	S16	SM1200JD	S120



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.6	2.9	E	0.1	0.2
B	1.7	1.9	F	0.8	1.1
C	0.9	1.1	G	0.7	0.9
D	3.5	3.8			

PACKAGE INFORMATION

Package	MPQ	Leader Size
SOD-123JD	3K	7' inch

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Part Number						Unit		
		SM 120JD	SM 140JD	SM 160JD	SM 1100JD	SM 1150JD	SM 1200JD			
Maximum Recurrent Reverse Voltage	V _{RRM}	20	40	60	100	150	200	V		
Maximum RMS Voltage	V _{RMS}	14	28	42	70	105	140	V		
Maximum DC Blocking Voltage	V _{DC}	20	40	60	100	150	200	V		
Maximum Instantaneous Forward Voltage @ I _{FM} = 1A	V _F	0.55		0.7	0.85	0.9		V		
Maximum Average Forward Rectified Current	I _(AV)	1						A		
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	30						A		
Maximum DC Reverse Current T _A = 25°C at Rated DC Blocking Voltage	I _R	0.3			0.2			mA		
		10			5					
Typical Junction Capacitance ¹	C _J	110		80						
Typical thermal resistance junction to Lead ²	R _{θJL}	20						°C / W		
Typical thermal resistance junction to Lead ²	R _{θJC}	40						°C / W		
Operating Temperature Range	T _J	-55~125						°C		
Storage Temperature Range	T _{STG}	-55~150						°C		

Notes :

1. Measured at f=1.0MHz, V_R=4.0V
2. FR4 Board Heat sink size: 10*10*0.2mm.

CHARACTERISTIC CURVES

Fig.1 Forward Current Derating Curve

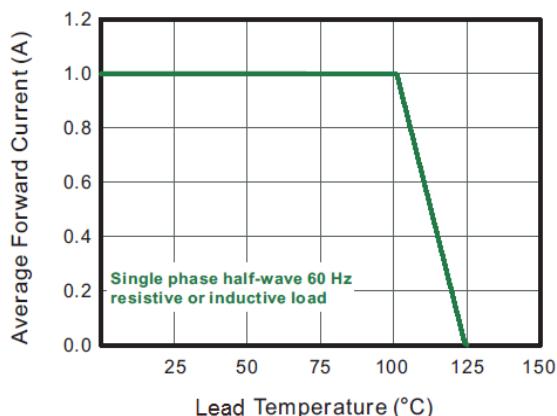


Fig.3 Typical Forward Characteristic

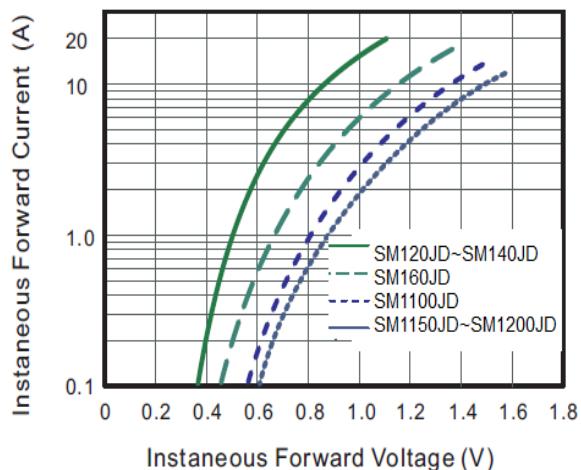


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

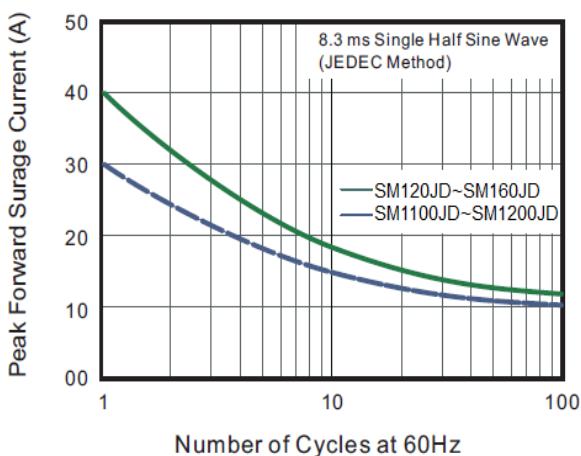


Fig.2 Typical Reverse Characteristics

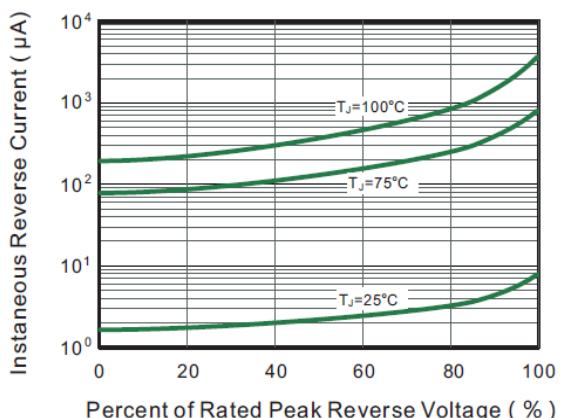


Fig.4 Typical Junction Capacitance

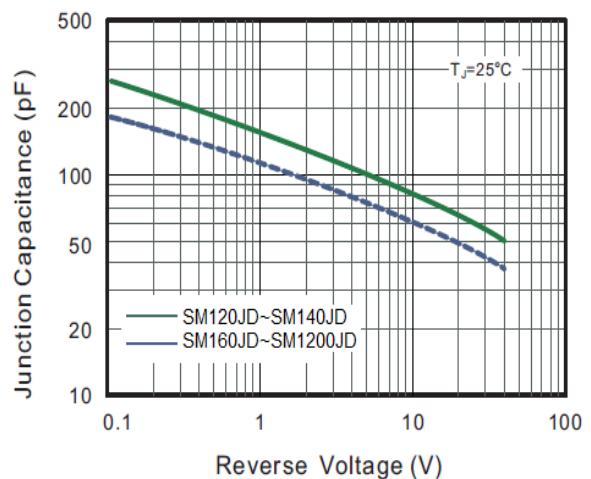


Fig.6-Typical Transient Thermal Impedance

